## IN THE CLAIMS

Claim 1 (currently amended). An antistatic pressure-sensitive adhesive tape of multilayer construction from comprising a carrier layer, and at least one pressure-sensitive adhesive layer, characterized in that the pressure-sensitive adhesive tape comprises and at least one additional electrically conductive layer between the carrier layer and a pressure-sensitive adhesive layer.

Claim 2 (currently amended). The antistatic pressure-sensitive adhesive tape of claim 1, characterized in that wherein the electrically conductive layer comprises electrically conductive particles, preferably of metal, electrically doped materials or electrically conductive polymers.

Claim 3 (currently amended). The antistatic pressure-sensitive adhesive tape of claim 1, characterized in that wherein the electrically conductive layer comprises homogeneously distributed electrically conductive materials, preferably electrically doped materials, electrically conductive polymers or electrically conductive organic salts, in an amount of preferably 5% to 60%, more preferably 10% to 50% by weight.

Claim 4 (currently amended). The antistatic pressure-sensitive adhesive tape of any one of claims 1 to 3, characterized in that claim 1, wherein the electrically conductive layer comprises electrically conductive conjugated polymers, especially 3,4-PEDT.

Claim 5 (currently amended). The antistatic pressure-sensitive adhesive tape of any one of claims 1 to 4, characterized in that claim 1, wherein the pressure-sensitive adhesive layer comprises a polyacrylate pressure-sensitive adhesive, based preferably on methacrylate.

Claim 6 (currently amended). The antistatic pressure-sensitive adhesive tape of any one of claims 1 to 5, characterized in that claim 1, wherein the pressure-sensitive

adhesive layer exhibits a shrinkback.

Claim 7 (currently amended). The antistatic pressure-sensitive adhesive tape of any one of claims 1 to 6 claim 1, characterized by comprising the following multilayer construction:

pressure-sensitive adhesive layer/<u>electrically conductive layer/</u>carrier layer/<u>pressure sensitive adhesive layer</u>.

Claim 8 (currently amended). The antistatic pressure-sensitive adhesive tape of any one of claims 1 to 6, characterized by claim 1, comprising the following multilayer construction:

pressure-sensitive adhesive layer/electrically conductive layer/carrier layer/electrically conductive layer/pressure sensitive adhesive layer.

Claim 9 (currently amended). The antistatic pressure-sensitive adhesive tape of any one of claims 1 to 6, characterized by claim 1, comprising the following multilayer construction:

pressure-sensitive adhesive layer/electrically conductive layer/carrier layer/pressure sensitive adhesive layer.

Claim 10 (currently amended). The use of the antistatic pressure-sensitive adhesive tape of any one of claims 1 to 9 claim 1 for producing in the form of a punched products.

Claim 11 (new). The antistatic pressure-sensitive adhesive tape of claim 2, wherein said electrically conductive particles are particles of a material selected from the group consisting of metal, electrically doped materials or electrically conductive polymers.

Claim 12 (new). The antistatic pressure-sensitive adhesive tape of claim 3, wherein said homogeneously distributed electrically conductive materials are selected from the group consisting of electrically doped materials, electrically conductive polymers or

electrically conductive organic salts, and are present in an amount of 5% to 60% by weight of the electrically conductive layer.

Claim 13 (new). The antistatic pressure-sensitive adhesive tape of claim 12, wherein said electrically conductive materials are present in an amount of 10% to 50% by weight.

Claim 14 (new). The antistatic pressure-sensitive adhesive tape of claim 4, wherein said electrically conductive conjugated polymers are 3,4-PEDT.

Claim 15 (new). The antistatic pressure-sensitive adhesive tape of claim 5, whereien said polyacrylate is a polymethacrylate.